

FORM PTO-1595

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EET U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office  
Atty. Docket No. 06542.0010

To the Assistant Com  
Please record the att

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documents or copy thereof. ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):

Jau-Ho JEAN  
Shih-Chun LIN

Additional names(s) of conveying party(ies)  
attached?  Yes  No

3. Nature of conveyance:

Assignment  Merger  
 Security Agreement  Change of Name  
 Other

Execution Date: February 24, 1998

2. Name and address of receiving party(ies):

Name: National Science Council

Internal Address:

Street Address: 106 Sec. 2, Ho-Ping E. Rd.,  
Taipei, Taiwan, R.O.C.

City:

State: ZIP:

Additional name(s) & address(es) attached?  
 Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application,  
the execution date of the application is: February 24, 1998

A. Patent Application Nos.

B. Patent No. (s)

Additional numbers attached?  YES  NO

5. Name and address of party to whom  
correspondence concerning document  
should be mailed:

Name: Mr. Ernest F. Chapman  
Internal Address:  
Finnegan, Henderson, Farabow, Garrett  
& Dunner, L.L.P.

Street Address:  
1300 I Street, N.W.  
City: Washington, D.C.  
State: ZIP: 20005

6. Total number of applications and patents  
involved 1

7. Total fee (37 CFR 3.41): \$ 40.00  
 Enclosed  
 Authorized to be charged to  
deposit account

8. Deposit account number: 06-0916

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct  
and any attached copy is a true copy of the original document.

Ernest F. Chapman  
Name of Person Signing

Signature

May 20, 1998  
Date

Total number of pages including cover sheet, attachments and document: 2

J:526 U.S. PTO  
09/081590  
05/20/98

**ASSIGNMENT OF U.S. RIGHTS TO CORPORATION**

WHEREAS,

Inventor(s)  
Name,  
Address,  
Citizenship

- ▶ 1. Jau-Ho Jean residing at 101 Sec. 2, Kuang-Fu Rd.,  
Hsinchu City, Taiwan, R.O.C.  
and a citizen of R.O.C.;
- ▶ 2. Shih-Chun Lin residing at 101 Sec. 2, Kuang-Fu Rd.,  
Hsinchu City, Taiwan, R.O.C.  
and a citizen of R.O.C.;
- ▶ 3. \_\_\_\_\_ residing at \_\_\_\_\_  
\_\_\_\_\_ and a citizen of \_\_\_\_\_;

Date Patent  
Declaration  
Signed and  
Title

(herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on \_\_\_\_\_ for this invention, which application is entitled LOW-FIRE DIELECTRIC COMPOSITION AND ITS USE IN LAMINATED MICROWAVE DIELECTRIC CERAMIC ELEMENTS and which has been given

Serial No. and  
Filing Date

▶ Serial Number \_\_\_\_\_ and the filing date of \_\_\_\_\_;

Name of  
Corporation

▶ AND WHEREAS National Science Council (herein called "ASSIGNEE"), a corporation organized under the laws of R.O.C., and having an office and place of business at 106 Sec. 2, Ho-Ping E. Rd., Taipei, Taiwan, R.O.C.

State or  
Country of  
Incorporation  
and Address

▶ wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each Inventor  
Must Sign  
and Date

Note: No  
Legalization or  
Other Witness  
Required

*Jau-Ho Jean*

Signature Jau-Ho Jean

24 February 1998

Date

*Shih-Chun Lin*

Signature Shih-Chun Lin

24 February 1998

Date

Signature \_\_\_\_\_

Date \_\_\_\_\_

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